

Title (en)
POLISHING TOOL AND PROCESSING METHOD FOR MEMBER

Title (de)
POLIERWERKZEUG UND VERARBEITUNGSVERFAHREN FÜR EIN ELEMENT

Title (fr)
OUTIL DE POLISSAGE ET PROCÉDÉ DE TRAITEMENT POUR ÉLÉMENT

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Application
EP 14834968 A 20140806

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Abstract (en)
[origin: EP3031577A1] The present invention relates to a method for polishing an object having a certain shape and, more particularly, to a polishing method using a polishing tool provided with a polishing pad including a polishing surface shaped in conformance with a curved surface of an object to be polished to efficiently and uniformly polish the curved surface of the object. A polishing tool of the present invention is provided with a polishing pad including a polishing surface shaped in conformance with a curved surface of an object to be polished to uniformly contact the curved surface of the object. The polishing pad preferably has a Shore A hardness of 5 or greater and a surface formed by at least one of a cloth, a non-woven fabric, a resin processed non-woven fabric, synthetic leather, synthetic resin foam, and a composite thereof. A polishing method of the present invention uses a polishing tool including a polishing surface shaped in conformance with a curved surface of an object to be polished to uniformly contact the curved surface of the object and polish the curved surface of the object.

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Citation (search report)
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